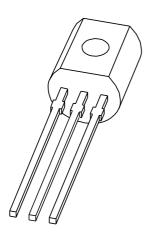
DISCRETE SEMICONDUCTORS

DATA SHEET



BF421; BF423PNP high voltage transistors

Product specification Supersedes data of 1996 Dec 09 2004 Nov 10





Philips Semiconductors Product specification

PNP high voltage transistors

BF421; BF423

FEATURES

• Low feedback capacitance.

APPLICATIONS

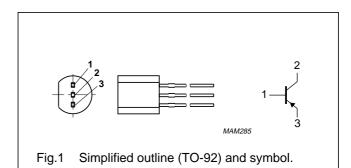
• Class-B video output stages in colour television and professional monitor equipment.

DESCRIPTION

PNP transistors in a TO-92 plastic package. NPN complements: BF420 and BF422.

PINNING

PIN	DESCRIPTION
1	base
2	collector
3	emitter



ORDERING INFORMATION

TYPE NUMBER		PACKAGE	
TIPE NUMBER	NAME	DESCRIPTION	VERSION
BF421	SC-43A	plastic single-ended leaded (through hole) package; 3 leads	SOT54
BF423			

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	BF421		_	-300	V
	BF423		_	-250	V
V _{CEO}	collector-emitter voltage	open base			
	BF421		_	-300	V
	BF423		_	-250	V
I _{CM}	peak collector current		-	-100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	_	830	mW
h _{FE}	DC current gain	$V_{CE} = -20 \text{ V}; I_{C} = -25 \text{ mA}$	50	_	
C _{re}	feedback capacitance	$V_{CE} = -30 \text{ V}; I_C = I_c = 0 \text{ A}; f = 1 \text{ MHz}$	_	1.6	pF
f _T	transition frequency	$V_{CE} = -10 \text{ V}; I_{C} = -10 \text{ mA}; f = 100 \text{ MHz}$	60	_	MHz

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter			
	BF421		_	-300	V
	BF423		_	-250	V
V _{CEO}	collector-emitter voltage	open base			
	BF421		_	-300	V
	BF423		_	-250	V
V _{EBO}	emitter-base voltage	open collector	-	-5	V
I _C	collector current (DC)		_	-50	mA
I _{CM}	peak collector current		_	-100	mA
I _{BM}	peak base current		_	-50	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C; note 1	_	830	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	ambient temperature		-65	+150	°C

Note

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	note 1	150	K/W

Note

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = -200 V; I _E = 0 A	_	-10	nA
		$V_{CB} = -200 \text{ V}; I_E = 0 \text{ A}; T_j = 150 ^{\circ}\text{C}$	_	-10	μΑ
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0 \text{ A}$	_	-50	nA
h _{FE}	DC current gain	$V_{CE} = -20 \text{ V}; I_{C} = -25 \text{ mA}$	50	_	
V _{CEsat}	collector-emitter saturation voltage	$I_C = -30 \text{ mA}; I_B = -5 \text{ mA}$	_	-0.6	V
C _{re}	feedback capacitance	$V_{CE} = -30 \text{ V}; I_C = i_c = 0 \text{ A}; f = 1 \text{ MHz}$	_	1.6	pF
f _T	transition frequency	$V_{CE} = -10 \text{ V}; I_{C} = -10 \text{ mA}; f = 100 \text{ MHz}$	60	_	MHz

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^{1.} Transistor mounted on a printed-circuit board.

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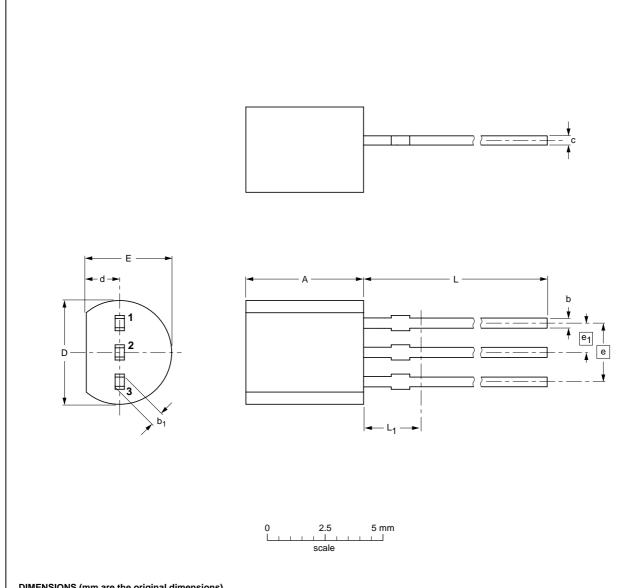
PNP high voltage transistors

BF421; BF423

PACKAGE OUTLINE

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



DIMENSIONS (mm are the original dimensions)

UNIT	A	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.	
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5	

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE	REFERENCES							
VERSION	IEC	JEDEC	JEITA			ISSUE DATE		
SOT54		TO-92	SC-43A			97-02-28 04-06-28		

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DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Notes

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Printed in The Netherlands

R75/03/pp6

Date of release: 2004 Nov 10

Document order number: 9397 750 13583

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